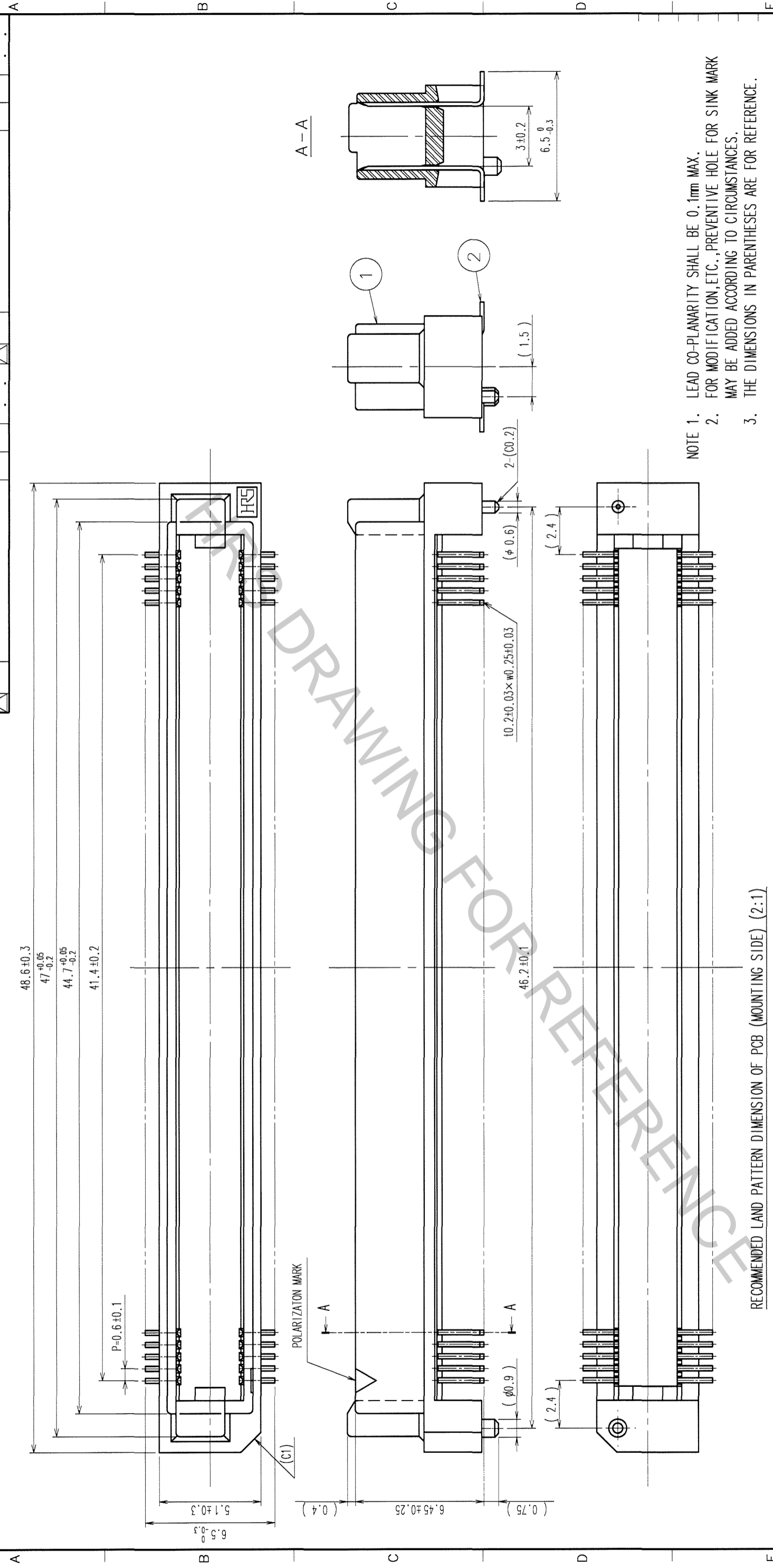
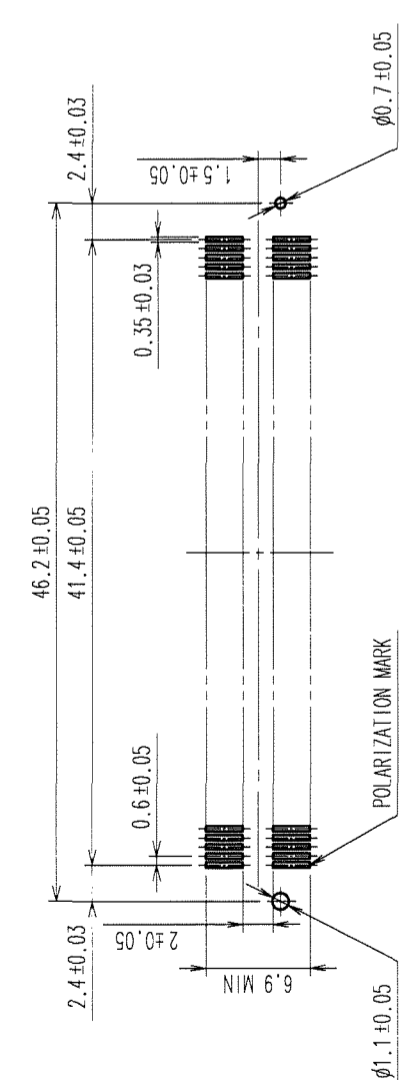


COUNT	DESCRIPTION OF REVISIONS	BY	CHKD	DATE	COUNT	DESCRIPTION OF REVISIONS	BY	CHKD	DATE
△					△				
△					△				
△					△				



NOTE 1. LEAD CO-PLANARITY SHALL BE 0.1mm MAX.  
 2. FOR MODIFICATION, ETC., PREVENTIVE HOLE FOR SINK MARK MAY BE ADDED ACCORDING TO CIRCUMSTANCES.  
 3. THE DIMENSIONS IN PARENTHESES ARE FOR REFERENCE.

RECOMMENDED LAND PATTERN DIMENSION OF PCB (MOUNTING SIDE) (2:1)



1	PPS	LIGHT BROWN (UL94V-0)	2	PHOSPHOR BRONZE	CONTACT AREA: GOLD 0.1 μ m min. LEAD AREA: TIN-PLATING 1 μ m min. UNDER PLATING: NICKEL 1 μ m min.
NO.	MATERIAL	FINISH, REMARKS	NO.	MATERIAL	FINISH, REMARKS
CODE NO. (OLD) CL			DRAWN K. NAKAMURA	DESIGNED K. NAKAMURA	CHECKED K. Ogawa
			05.11.17	05.11.17	05.11.17
DRAWING NO. EDC3-150845-25		PART NO. FX8C-140P-SV2(71)		APPROVED H. Okawa	
SCALE 5 : 1		CODE NO. CL578-0547-0-71		RELEASED	
UNITS mm		HIROSE ELECTRIC CO., LTD.		FORM NO. 229	

TO	
PCK	